



DMN3022LFG

30V SYNCHRONOUS N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI3333-8 (Type D)

Product Summary

| Device | BV _{DSS} | R _{DS(ON)} max |
|--------|-------------------|--|
| Q1 | 30V | $22m\Omega$ @ V _{GS} = 5V, I _D = 10A |
| Q2 | 30V | $8m\Omega @ V_{GS} = 5V, I_D = 10A$ |

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

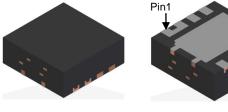
- **DC-DC Converters**
- **Power Management Functions**
- Analog Switch

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

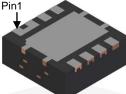
Mechanical Data

- Case: PowerDI[®]3333-8 (Type D)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.044 grams (Approximate)



PowerDI3333-8 (Type D)

Top View



Bottom View

D1 8 S1/D2 D1 7 S1/D2 S2 G1 6 S1/D2 3 S1/D2 5 G2 4

Top View Pin Configuration

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|------------------------|--------------------|
| DMN3022LFG-7 | PowerDI3333-8 (Type D) | 1000 / Tape & Reel |
| DMN3022LFG-13 | PowerDI3333-8 (Type D) | 3000 / Tape & Reel |

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



N06 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Q1 | Q2 | Unit |
|--|--|------------------|------------|-----|------|
| Drain-Source Voltage | | V _{DSS} | 30 | | V |
| Gate-Source Voltage | | V _{GSS} | ±10 | | V |
| | T _C = +25°C T _C = +70°C | ID | 15 12 | | A |
| Continuous Drain Current @ $V_{GS} = 5V$ | T _A = +25°C T _A = +70°C | ID | 7.6 6.1 | ; | A |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | IDM | 50 | 100 | A |
| Avalanche Current (Note 6) L = 0.1mH | | I _{AS} | 24 | 43 | A |
| Avalanche Energy (Note 6) L = 0.1mH | | E _{AS} | 28 | 92 | mJ |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|--|------------------------|-------------------|-------------|------|--|
| Total Power Dissipation | $T_A = +25^{\circ}C$ | 6 | 1.96 | W | |
| | T _A = +70°C | PD | 1.25 | vv | |
| Thermal Desistance, Junction to Ambient (Note 5) | Steady State | D | 64 | °C/W | |
| Thermal Resistance, Junction to Ambient (Note 5) | t < 10s | $R_{	heta}JA$ | 36 | | |
| Thermal Resistance, Junction to Case (Note 5) | | R _θ JC | 8.7 | | |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C | |

Electrical Characteristics Q1 (@T_A = +25°C, unless otherwise specified.)

| | 1 | | | | | |
|--|---------------------|-----|------|------|------|---|
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
| OFF CHARACTERISTICS (Note 7) | - | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | _ | — | V | $V_{GS} = 0V, I_D = 250 \mu A$ |
| Zero Gate Voltage Drain Current | IDSS | — | — | 1 | μA | $V_{DS} = 20V, V_{GS} = 0V$ |
| Gate-Source Leakage | I _{GSS} | — | — | ±100 | nA | $V_{GS} = \pm 10V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 7) | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 1 | 1.4 | 2.1 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ |
| Static Drain-Source On-Resistance | R _{DS(ON)} | — | 16 | 22 | mΩ | $V_{GS} = 5V, I_D = 10A$ |
| Forward Transfer Admittance | Y _{fs} | — | 17 | _ | S | $V_{DS} = 5V, I_D = 8A$ |
| Diode Forward Voltage | V _{SD} | _ | 0.84 | 1 | V | $V_{GS} = 0V, I_{S} = 8A$ |
| DYNAMIC CHARACTERISTICS (Note 8) | | | • | | | * |
| Input Capacitance | Ciss | — | 370 | 481 | pF | $V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz |
| Output Capacitance | Coss | _ | 176 | 228 | | |
| Reverse Transfer Capacitance | Crss | — | 8.2 | 10.6 | | |
| Gate Resistance | Rg | _ | 2.5 | 6.5 | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$ |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | — | 2.8 | 3.7 | | |
| Total Gate Charge at V _{TH} | Q _{g(TH)} | _ | 0.35 | _ | nC | |
| Gate-Source Charge | Q _{gs} | — | 0.6 | _ | nc | V _{DS} = 15V, I _D = 8A |
| Gate-Drain Charge | Q _{gd} | _ | 0.5 | _ | | |
| Turn-On Delay Time | t _{D(ON)} | _ | 4.5 | 6.7 | | V_{DD} = 15V, V_{GS} = 4.5V, I _D = 8A, R_G = 2 Ω |
| Turn-On Rise Time | t _R | _ | 1.8 | | | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 7.2 | 10.8 | ns | |
| Turn-Off Fall Time | tF | — | 1.9 | _ | 1 | |
| Reverse Recovery Time | t _{RR} | _ | 11.5 | _ | ns | |
| Reverse Recovery Charge | Q _{RR} | — | 6.9 | | nC | I _F = 8A, di/dt = 300A/µs |

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



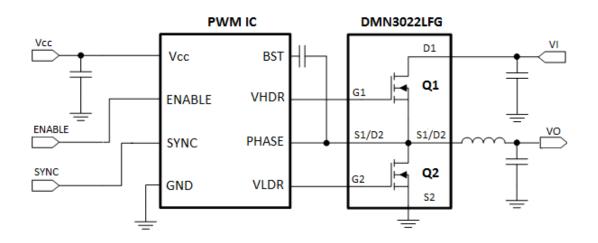
Electrical Characteristics Q2 (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|------|------|------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | — | - | V | $V_{GS} = 0V, I_D = 250 \mu A$ | |
| Zero Gate Voltage Drain Current TJ = +25°C | I _{DSS} | _ | _ | 1.0 | μA | $V_{DS} = 20V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | _ | — | ±100 | nA | $V_{GS} = \pm 10V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 0.8 | 0.96 | 1.2 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | — | 6.4 | 8 | mΩ | $V_{GS} = 5V, I_D = 10A$ | |
| Forward Transfer Admittance | Y _{fs} | — | 33 | — | S | $V_{DS} = 5V, I_D = 8A$ | |
| Diode Forward Voltage | V _{SD} | _ | 0.78 | 1 | V | $V_{GS} = 0V, I_{S} = 8A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | C _{iss} | — | 766 | 996 | pF | V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz | |
| Output Capacitance | C _{oss} | — | 441 | 573 | pF | | |
| Reverse Transfer Capacitance | Crss | — | 19 | 25 | pF | | |
| Gate Resistance | Rg | _ | 0.69 | 1.5 | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge ($V_{GS} = 4.5V$) | Qg | — | 6.1 | 8 | nC | | |
| Total Gate Charge at V _{TH} | Q _{g(TH)} | _ | 0.47 | - | nC | | |
| Gate-Source Charge | Q _{qs} | — | 0.8 | _ | nC | $V_{DS} = 15V, I_D = 8A$ | |
| Gate-Drain Charge | Q _{gd} | _ | 1.1 | - | nC | | |
| Turn-On Delay Time | t _{D(ON)} | | 5.6 | 8.4 | ns | | |
| Turn-On Rise Time | t _R | _ | 2.5 | _ | ns | $V_{DD} = 15V, V_{GS} = 4.5V,$ | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 11.7 | 17.5 | ns | $I_D = 8A, R_G = 2\Omega$ | |
| Turn-Off Fall Time | tF | _ | 2.4 | _ | ns |] | |
| Reverse Recovery Time | t _{RR} | _ | 27.9 | | ns | | |
| Reverse Recovery Charge | Q _{RR} | | 9.9 | _ | nC | I _F = 8A, di/dt = 300A/μs | |

 Notes:
 7. Short duration pulse test used to minimize self-heating effect.

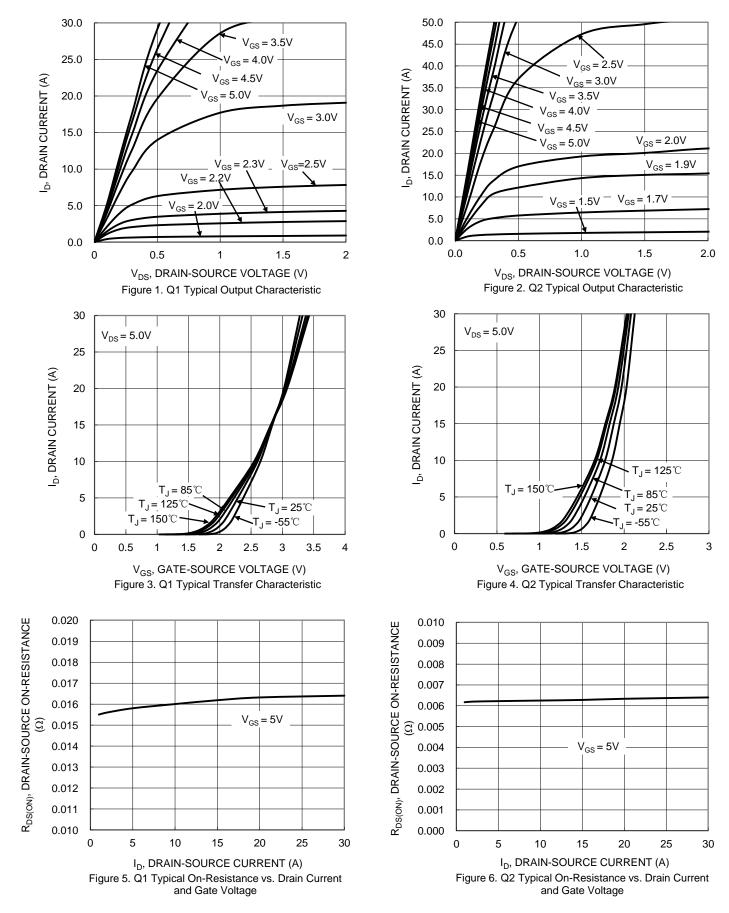
 8. Guaranteed by design. Not subject to product testing.

Typical Circuit

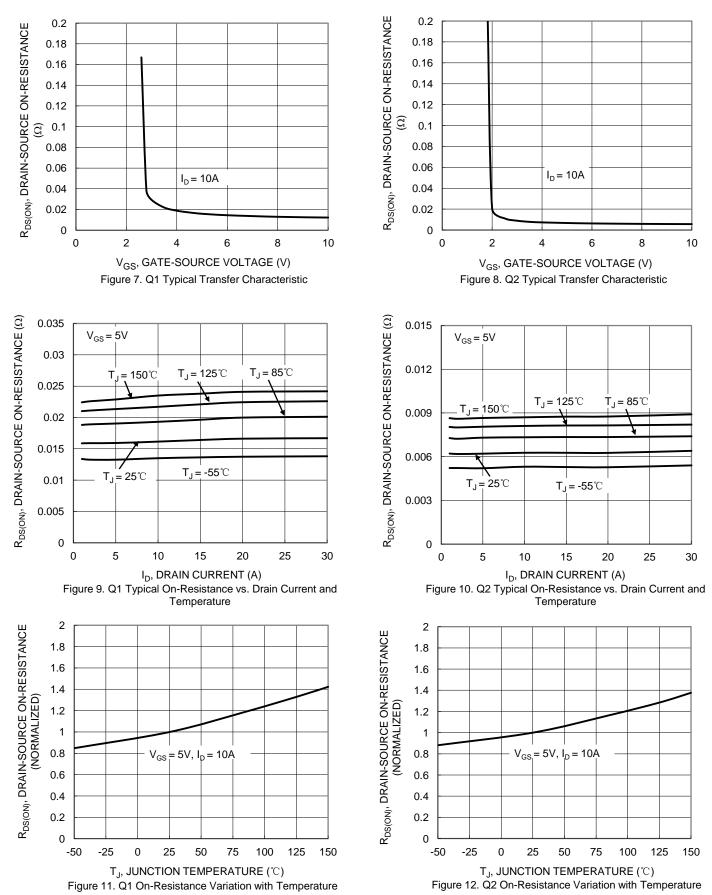




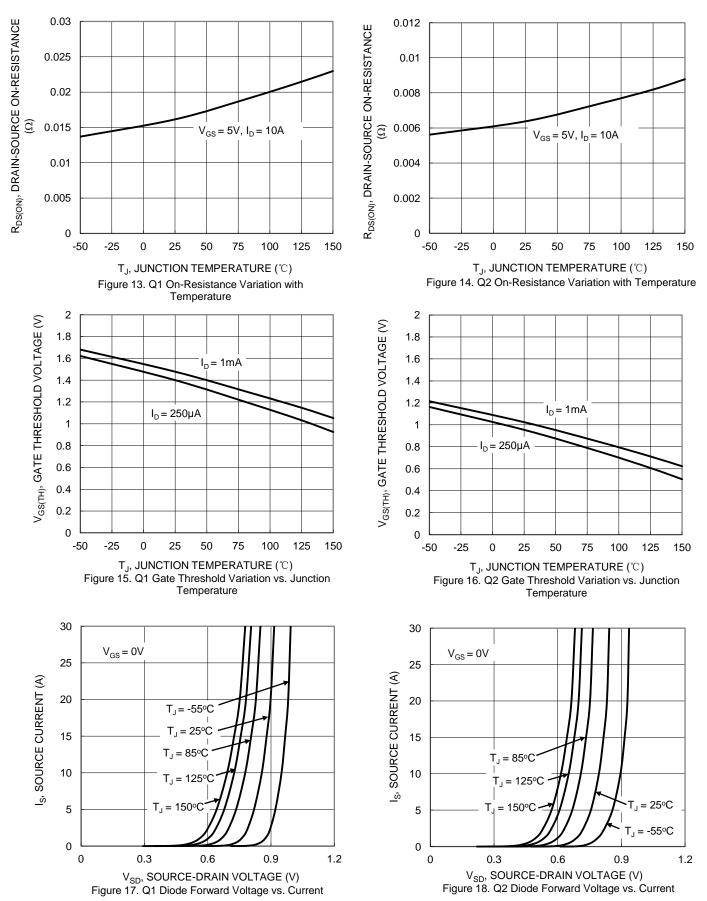
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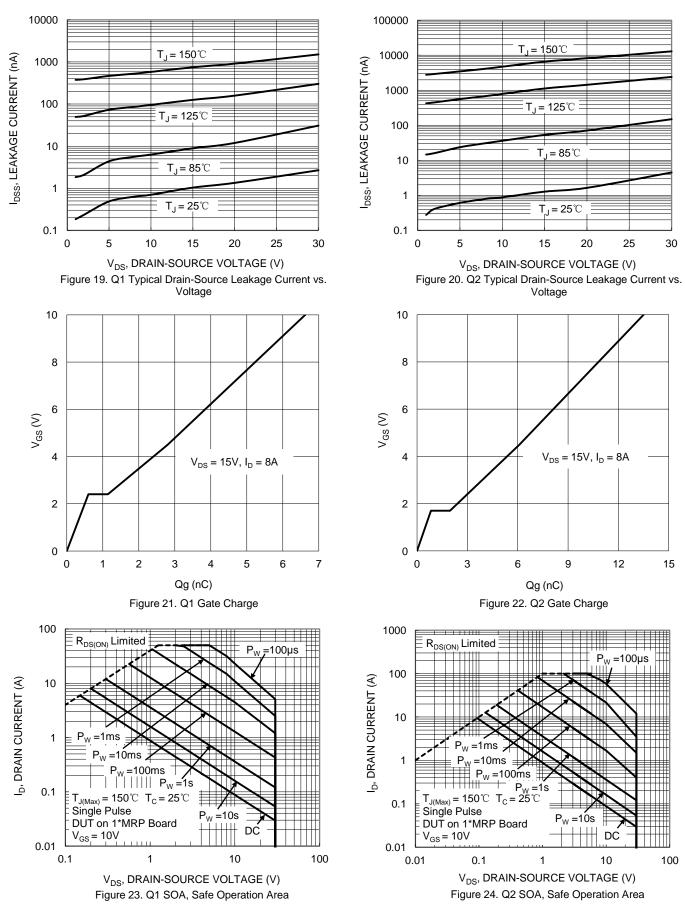






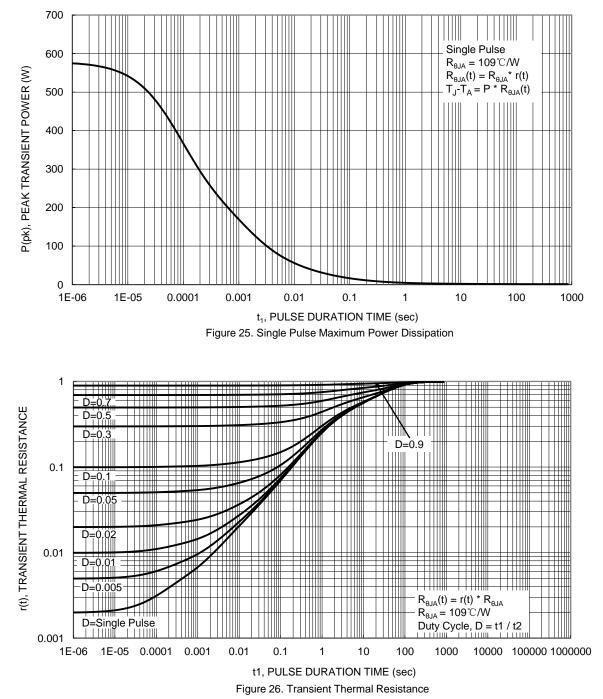


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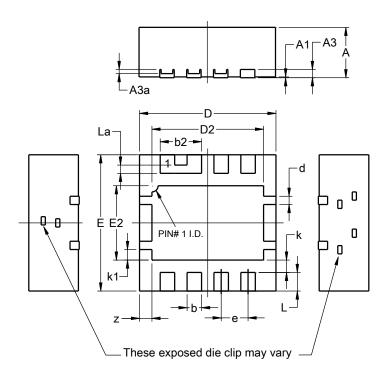




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type D)

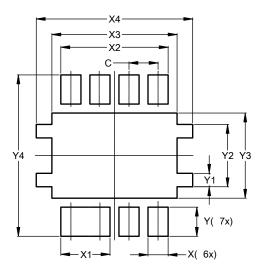


| | PowerDI3333-8 (Type D) | | | | | | |
|-----|---------------------------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 1.17 | 1.23 | 1.20 | | | | |
| A1 | 0.00 | 0.05 | 0.02 | | | | |
| A3 | 0.15 | 0.25 | 0.20 | | | | |
| A3a | 0.05 | 0.15 | 0.10 | | | | |
| b | 0.30 | 0.40 | 0.35 | | | | |
| b2 | 0.95 | 1.05 | 1.00 | | | | |
| D | 3.20 | 3.40 | 3.30 | | | | |
| D2 | 2.65 | 2.75 | 2.70 | | | | |
| E | 3.20 | 3.40 | 3.30 | | | | |
| E2 | 1.75 | 1.85 | 1.80 | | | | |
| d | 0.15 | 0.25 | 0.20 | | | | |
| е | | | 0.65 | | | | |
| k | | | 0.30 | | | | |
| k1 | 0.21 | 0.31 | 0.26 | | | | |
| L | 0.40 | 0.50 | 0.45 | | | | |
| La | 0.15 | 0.25 | 0.20 | | | | |
| z | 0.25 | 0.35 | 0.30 | | | | |
| All | All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type D)



| Dimensions | Value (in mm) | | |
|------------|------------------|--|--|
| С | 0.650 | | |
| Х | 0.450 | | |
| X1 | 1.100 | | |
| X2 | 2.400 | | |
| X3 | 2.800 | | |
| X4 | 3.500 | | |
| Y | 0.650 | | |
| Y1 | 0.300 | | |
| Y2 | 1.390 | | |
| Y3 | 1.900 | | |
| Y4 | 3.600 | | |



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